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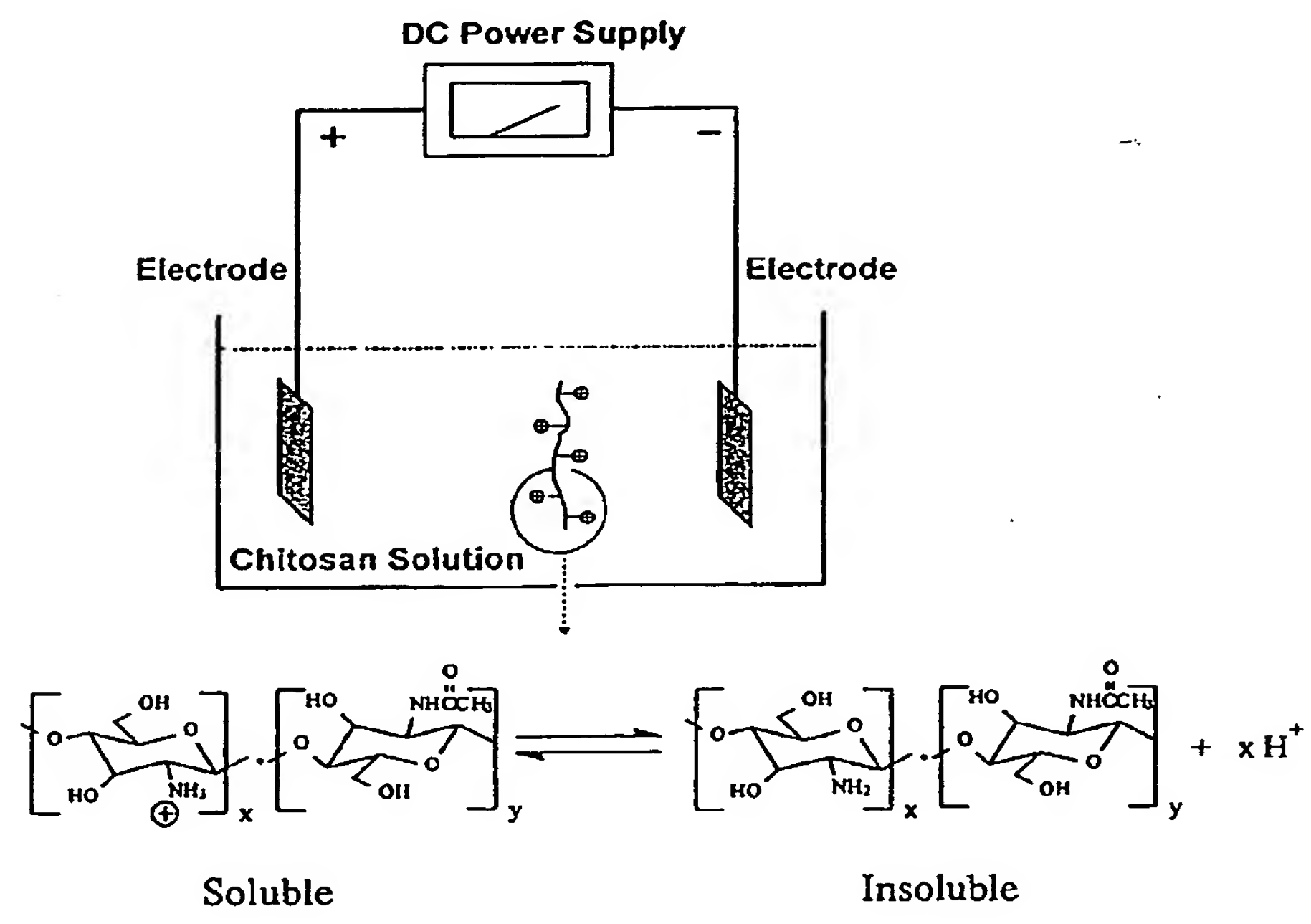
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(54) Title: ASSEMBLY OF CHITOSAN ONTO AN ELECTRODE SURFACE



(57) Abstract: The deposition of chitosan onto electrode surfaces is disclosed. Methods of depositing chitosan on surfaces are disclosed. Materials comprising chitosan deposited on a substrate are also disclosed.

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